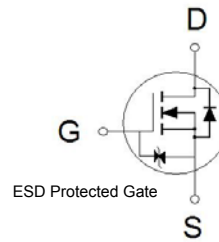


PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
20V	2.4m Ω	87A

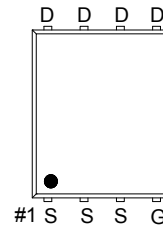


Features

- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.
- Products Integrated ESD diode with ESD Protected.

Applications

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications.



G. GATE
D. DRAIN
S. SOURCE

100% UIS Tested
100% Rg Tested

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GS}	± 12	V
Continuous Drain Current ⁴	$T_C = 25\text{ }^{\circ}\text{C}$	I_D	87	A
	$T_C = 100\text{ }^{\circ}\text{C}$		55	
Pulsed Drain Current ¹		I_{DM}	120	
Continuous Drain Current	$T_A = 25\text{ }^{\circ}\text{C}$	I_D	31	
	$T_A = 70\text{ }^{\circ}\text{C}$		25	
Avalanche Current		I_{AS}	51	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	130	mJ
Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	P_D	31	W
	$T_C = 100\text{ }^{\circ}\text{C}$		12.5	
Power Dissipation ³	$T_A = 25\text{ }^{\circ}\text{C}$	P_D	4	W
	$T_A = 70\text{ }^{\circ}\text{C}$		2.6	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	$^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$t \leq 10s$	$R_{\theta JA}$		30	°C / W
Junction-to-Ambient ²	Steady-State	$R_{\theta JA}$		51	
Junction-to-Case	Steady-State	$R_{\theta JC}$		4	

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

³The Power dissipation is based on $R_{\theta JA}$ $t \leq 10s$ value.

⁴Package limitation current is 51A.

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT	
			MIN	TYP	MAX		
STATIC							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.7	0.8	1.3		
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 10V$			± 30	μA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16V, V_{GS} = 0V$			1	μA	
		$V_{DS} = 10V, V_{GS} = 0V, T_J = 55\text{ }^{\circ}C$			10		
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 2.5V, I_D = 10A$		2.7	3.9	m Ω	
		$V_{GS} = 4.5V, I_D = 10A$		2	2.8		
		$V_{GS} = 10V, I_D = 15A$		1.7	2.4		
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 15A$		78		S	
DYNAMIC							
Input Capacitance	C_{iss}		$V_{GS} = 0V, V_{DS} = 10V, f = 1MHz$		3727		pF
Output Capacitance	C_{oss}				659		
Reverse Transfer Capacitance	C_{rss}				541		
Gate Resistance	R_g		$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		1.2		Ω
Total Gate Charge ²	Q_g	$V_{GS} = 10V$	$V_{DS} = 10V, V_{GS} = 10V, I_D = 15A$		88		nC
		$V_{GS} = 4.5V$			44		
Gate-Source Charge ²	Q_{gs}				3.6		
Gate-Drain Charge ²	Q_{gd}				18		
Turn-On Delay Time ²	$t_{d(on)}$			$V_{DS} = 10V, I_D \cong 15A, V_{GS} = 10V, R_{GEN} = 6\Omega$		40	
Rise Time ²	t_r				58		
Turn-Off Delay Time ²	$t_{d(off)}$				92		
Fall Time ²	t_f				36		

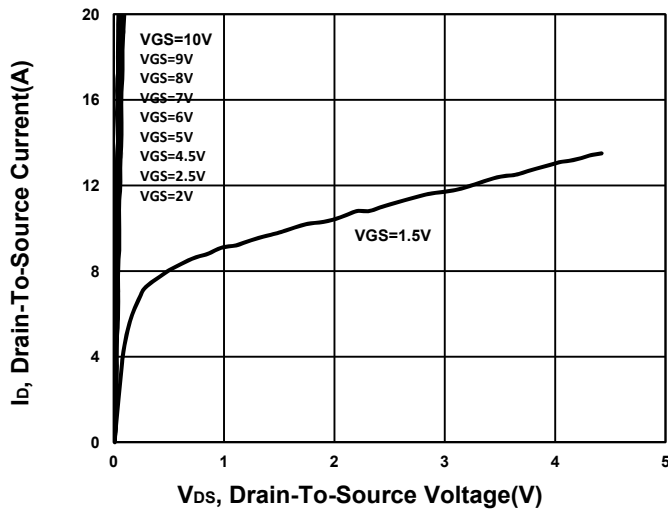
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)

Continuous Current	I _S			25	A
Forward Voltage ¹	V _{SD}	I _F = 15A, V _{GS} = 0V		1.2	V
Reverse Recovery Time	t _{rr}	I _F = 15A, dI _F /dt = 100A / μS	33		nS
Reverse Recovery Charge	Q _{rr}		18		nC

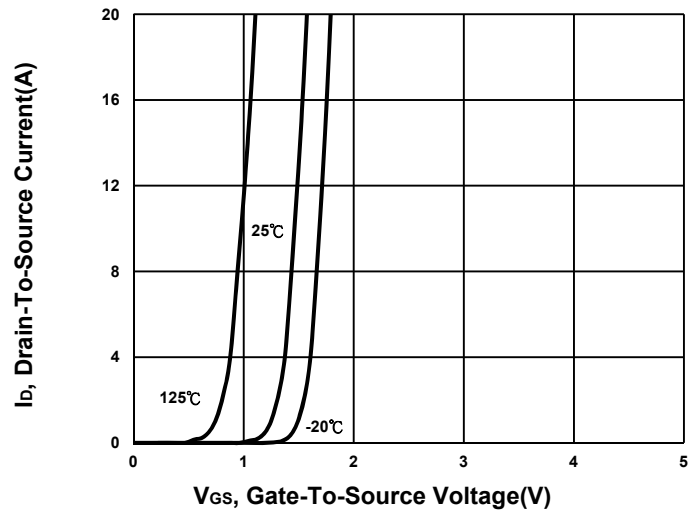
¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

²Independent of operating temperature.

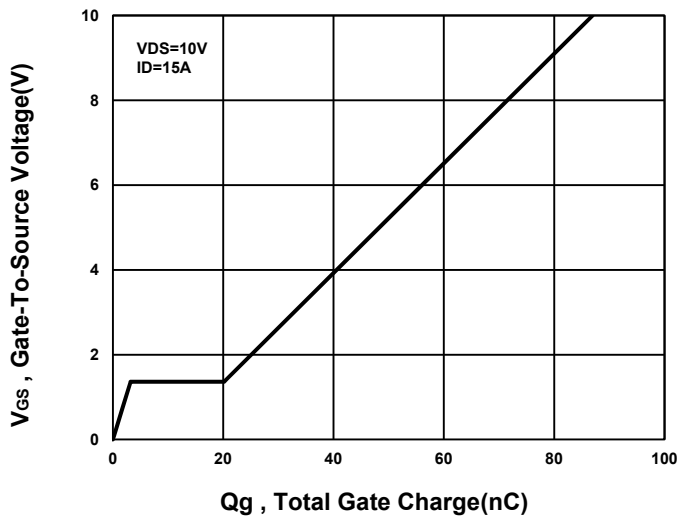
Output Characteristics



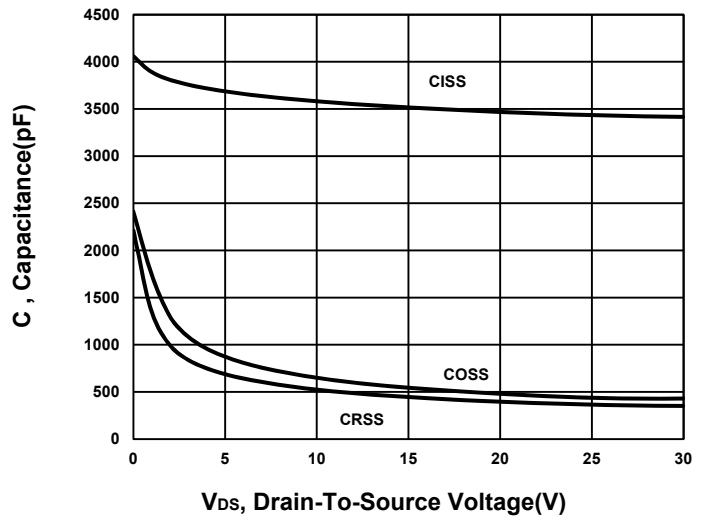
Transfer Characteristics



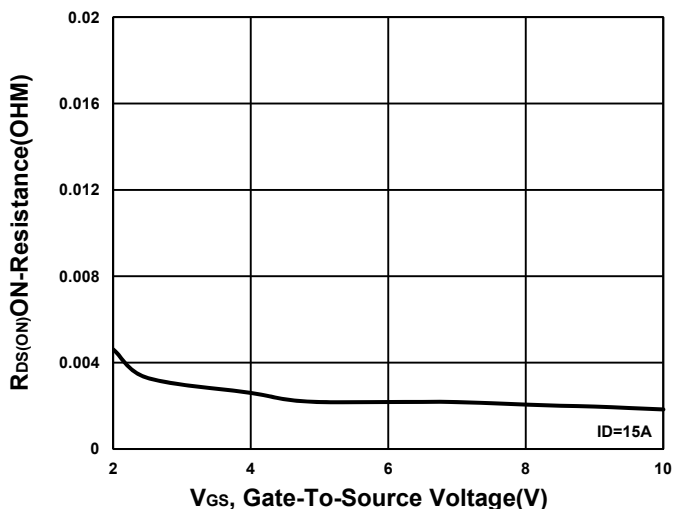
Gate charge Characteristics



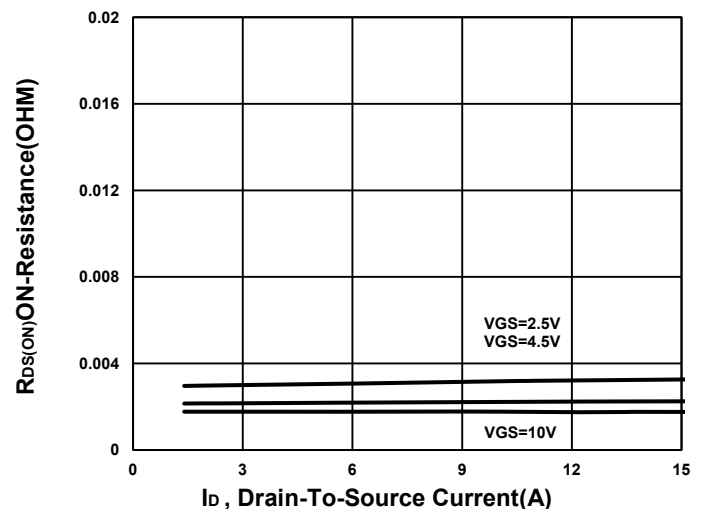
Capacitance Characteristic



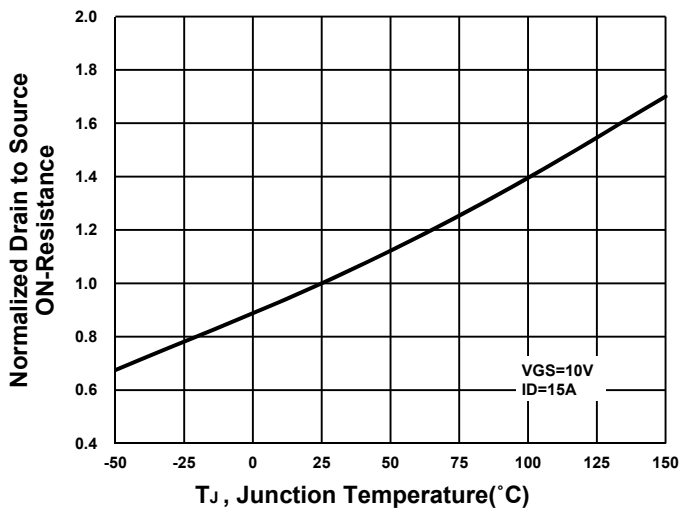
On-Resistance VS Gate-To-Source



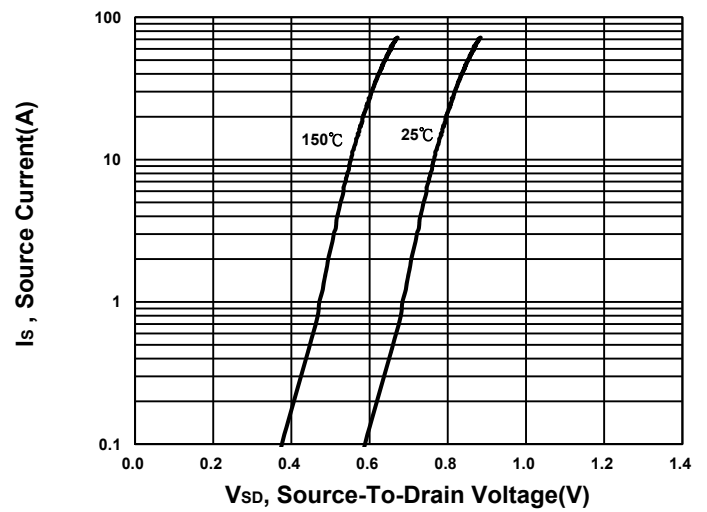
On-Resistance VS Drain Current



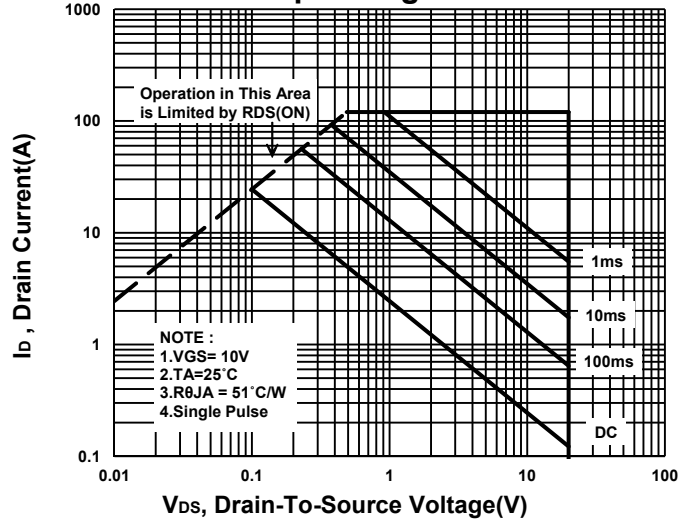
On-Resistance VS Temperature



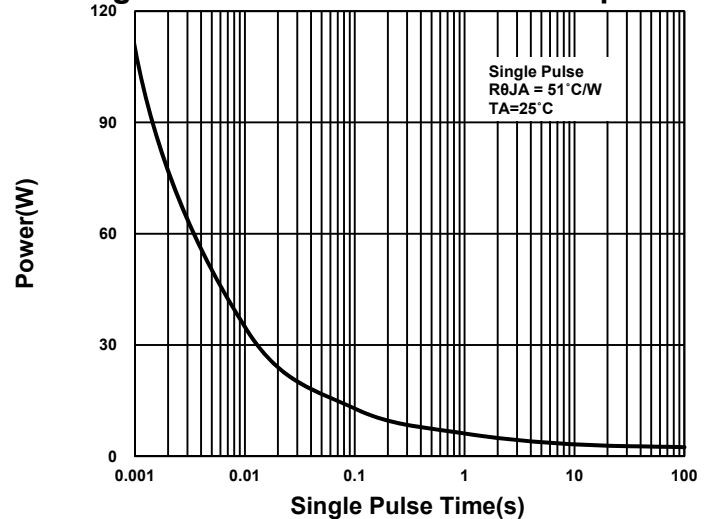
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

